



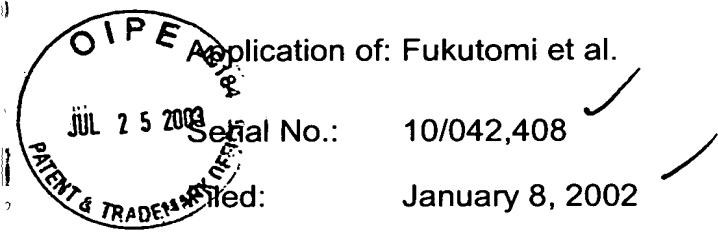
07-28-03

#8
Election/B
2813

w/Drawings
8/26/03
Mullen

Express Mail No.: EV 335 856 295 US

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE



Group Art Unit: 2813

Examiner: Berezny, Nema O.

Attorney Docket No.: 7426-082

For: Fabrication Process of Semiconductor Package and Semiconductor Package

RESPONSE TO REQUIREMENT FOR RESTRICTION UNDER 37 C.F.R. § 1.142
AND PRELIMINARY AMENDMENT UNDER 37 C.F.R. § 1.115

Mail Stop Non-Fee Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

In response to the Office Action mailed on June 26, 2003 in connection with the above-identified patent application and in accordance with the Rules of Practice, please enter the following amendments and consider the following remarks.
Submitted herewith is Appendix A, revised drawing sheets 1, 3 – 7, 9 – 13, 16 – 21, and 23 – 24.

RECEIVED
AUG - 1 2003
TECHNOLOGY CENTER 2800